

V1.0.0 GaAs pHEMT MMIC Power Amplifier DC-24GHz

### Features

- Frequency: DC-24GHz
- Small Signal Gain: 20dB Typical
- Gain Flatness: ±1.5dB Typical
- Noise Figure: 2.5dB Typical
- Psat: 31dBm Typical @ +12V/-0.45V
- Supply voltage:

VD =+12V VG=-0.45V

- Input/Output: 50Ω
- Die Size: 3.3 x 1.63 x 0.1mm

### **Typical Applications**

- Test Instrumentation
- Microwave Radio & VSAT
- Military & Space
- Telecom Infrastructure
- Fiber Optics

### **Electrical Specifications**

#### TA = +25°C, VD=+12V,VG= -0.45V IDD = 443mA Typical

Parameters	Min.	Тур.	Max.	Min.	Тур.	Max.	Units
Frequency	DC		10	10		24	GHz
Small Signal Gain	18	20		18	20		dB
Gain Flatness		±1.5			±0.5		dB
Noise Figure		2.5			4		dB
P1dB - Output 1dB Compression		29			28		dBm
Psat - Saturated Output Power		31			29.5		dBm
Input Return Loss		9			7		dB
Output Return Loss		15			15		dB
* Adjust VG slight	ly to obt	ain devi	ce curre	nt of 443	8 mA.	1	

### Functional Block Diagram



**MMW515T** 



V1.0.0 GaAs pHEMT MMIC Power Amplifier DC-24GHz

> 10 12 14 16 18 20 22 24 26 28 FREQUENCY (GHz)

### Measurement Plots: S-parameters

0 -2

-4

-6

-8 -10 -12 -12 -14 -16 -18 -20 -22

-24

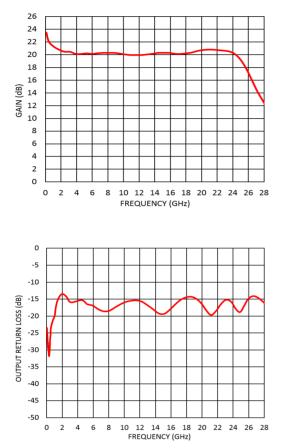
-26

-28

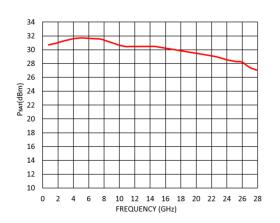
-30

0 2

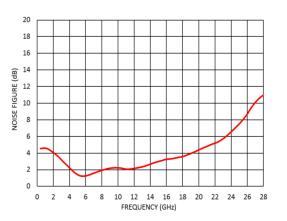
4 6 8



Measurement Plots: PSAT











V1.0.0 GaAs pHEMT MMIC Power Amplifier DC-24GHz

#### Absolute Maximum Ratings

Drain Bias Voltage (VD)	+14V		
Gate Bias Voltages(VG)	–1 to 0 V		
RF Input Power (RFIN)@(+12V)	+16dBm		
Channel Temperature	175 °C		
Continuous Pdiss (T = 85 °C) (derate 78mW/°C above 85 °C)	7W		
Thermal Resistance (channel to die bottom)	50°C/W		
Operating Temperature	-55°C to +85 °C		
Storage Temperature	-65°C to +150 °C		

### Typical Supply Current vs. VD,VG

VD (V)	VG (V)	IDD (mA)		
12	-0.45	443		

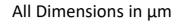


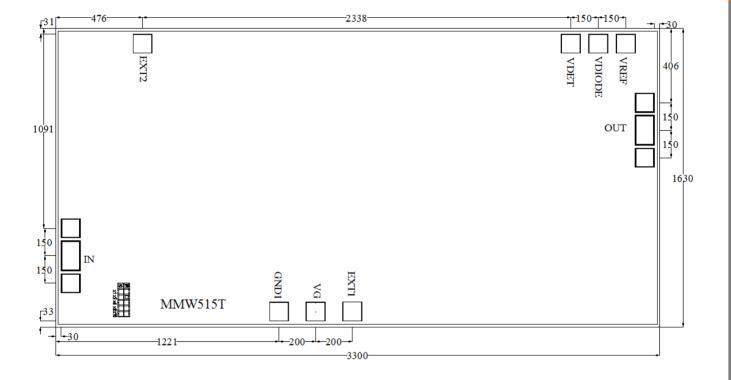
ELECTROSTATIC SENSITIVE DEVICE OBSERVE HANDLING PRECAUTIONS **MMW515T** 



GaAs pHEMT MMIC Power Amplifier DC-24GHz

Outline Drawing:





Notes:

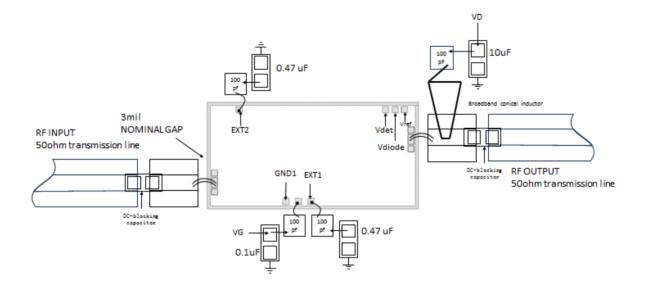
- 1. Die thickness: 100µm
- 2. DC bond pad is  $100*100\mu m^2$
- 3. RF IN/OUT bond pad is 100\*100µm<sup>2</sup>
- 4. Bond pad metalization: Gold
- 5. Backside metalization: Gold

**MMW515T** 



V1.0.0 GaAs pHEMT MMIC Power Amplifier DC-24GHz

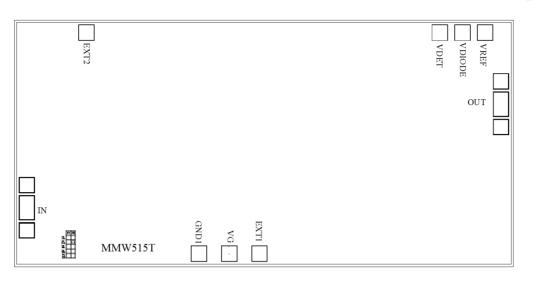
### Assembly Drawing



No.	Mnemonic	Description
1	RF IN	Signal input terminal, connected to 50 $\Omega$ circuit; blocking capacitor required.
2	RF OUT	Signal output terminal, connected to $50\Omega$ circuit; blocking capacitor required; external DC biasing network required; drain current provided.
3	VG	Amplifier Gate Controls. External bypass capacitors of 0.1µf and 100pf are required for these pads. ESD protection diodes are included and turn on below -1.0 V.
4	EXT1	External bypass pad; connect to external 100pf and 0.47uf bypass capacitor.
5	EXT2	External bypass pad; connect to external 100pf and 0.47uf bypass capacitor.
6	Vref	Detector ref
7	Vdiode	Detector bias
8	Vdet	Detector output
9	Die Bottom	Die bottom must be connected to RF and dc ground.



V1.0.0 GaAs pHEMT MMIC Power Amplifier DC-24GHz



# **Biasing and Operation**

#### **Turn ON procedure:**

- 1. Connect GND to RF and dc ground.
- 2. Set the gate bias voltages, VG1 to -1.0V.
- 3. Set the drain bias voltages VD to +12V.
- 4. Increase the gate bias voltages to achieve a quiescent supply current of 443 mA.
- 5. Apply RF signal.

#### Turn OFF procedure:

- 1. Turn off the RF signal.
- 2. Decrease the gate bias voltages, VG1 to -1.0V to achieve a  $l_{DQ} = 0$  mA (approximately).
- 3. Decrease the drain bias voltages to 0 V.
- 4. Increase the all gate bias voltages to 0 V.

#### Miller MMIC Inc. All rights reserved

Miller MMIC, Inc. holds exclusive rights to the information presented in its Data Sheet and any accompanying materials. As a premier supplier of cutting-edge RF solutions, Miller MMIC has made this information easily accessible to its clients.

Although Miller MMIC believes the information provided in its Data Sheet to be trustworthy, the company does not offer any guarantees as to its accuracy. Therefore, Miller MMIC bears no responsibility for the use of this information. It is worth mentioning that the information within the Data Sheet may be altered without prior notification.

Customers are encouraged to obtain and verify the most recent and pertinent information before placing any orders for Miller MMIC products. The information in the Data Sheet does not confer, either explicitly or implicitly, any rights or licenses with regards to patents or other forms of intellectual property to any third party.

The information provided in the Data Sheet, or its utilization, does not bestow any patent rights, licenses, or other forms of intellectual property rights to any individual or entity, whether in regards to the information itself or anything described by such information. Furthermore, Miller MMIC products are not intended for use as critical components in applications where failure could result in severe injury or death, such as medical or life-saving equipment, or life-sustaining applications, or in any situation where failure could cause serious personal injury or death.